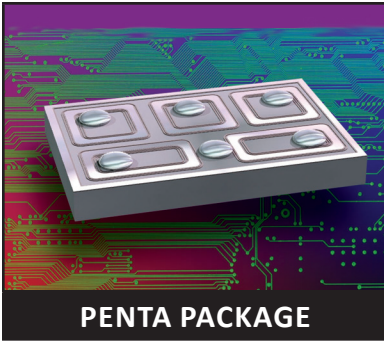


250W FLIP CHIP TVS ARRAY



DESCRIPTION

The SFC05-5 is a 5 Volt, flip chip transient voltage suppressor (TVS) array designed to provide protection for power bus, data, control or I/O lines. Rated at 250 Watts peak pulse power for an 8/20 μ s waveshape, this device protects 5 unidirectional lines or 4 bidirectional lines.

This device is a type of chip scale package (CSP) that can be mounted onto a printed circuit board or in a connector requiring a limited amount of space and is compatible with "pick and place" equipment for automatic assembly. The SFC05-5 is compatible with IEC 61000-4-2 (ESD), 61000-4-4(EFT) and 61000-4-5(Surge) requirements.

FEATURES

- Compatible with IEC 61000-4-2 (ESD): Air 15kV, Contact 8kV
- Compatible with IEC 61000-4-4 (EFT): 40A, 5/50ns
- Compatible with IEC 61000-4-5 (Surge): 24A, 8/20 μ s - Level 2(Line - Gnd) & Level 3 (Line - Line)
- ESD Protection > 25 kilovolts
- 250 Watts Peak Pulse Power per Line ($t_p = 8/20\mu$ s)
- Protects up to Five Unidirectional and Four Bidirectional Lines
- RoHS Compliant
- REACH Compliant

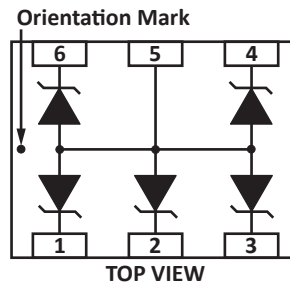
APPLICATIONS

- Cellular Phones
- SMART Phones
- PCMCIA Cards
- Ground Positioning System (GPS)

MECHANICAL CHARACTERISTICS

- Penta Flip Chip Package
- Approximate Weight: 0.73 milligrams
- Lead-Free Plating
- Solder Reflow Temperature:
 - Lead-Free - Sn/Ag/Cu, 96/3.5/0.5: 260-270°C
- Flammability Rating UL 94V-0
- 8mm Tape per EIA Standard 481
- Top Contacts: Solder Bump 0.004" in Height (Nominal)

CIRCUIT DIAGRAM



TYPICAL DEVICE CHARACTERISTICS
MAXIMUM RATINGS @ 25°C Unless Otherwise Specified

PARAMETER	SYMBOL	VALUE	UNITS
Peak Pulse Power (tp = 8/20μs) - See Figure 1	P_{PP}	250	Watts
Operating Temperature	T_A	-55 to 150	°C
Storage Temperature	T_{STG}	-55 to 150	°C

ELECTRICAL CHARACTERISTICS PER LINE @ 25°C Unless Otherwise Specified

PART NUMBER	RATED STAND-OFF VOLTAGE V_{WM} VOLTS	MINIMUM BREAKDOWN VOLTAGE @ 1mA $V_{(BR)}$ VOLTS	MAXIMUM CLAMPING VOLTAGE (Fig. 2) @ $I_p = 5A$ V_c VOLTS	MAXIMUM CLAMPING VOLTAGE (Fig. 2) @ 8/20μS $V_c @ I_{PP}$	MAXIMUM LEAKAGE CURRENT @ V_{WM} I_D μA	TYPICAL CAPACITANCE @ 0V, 1MHz C_j pF
SFC05-5	5.0	6.0	9.5	11.0V @ 24.0A	10	150

TYPICAL DEVICE CHARACTERISTICS

FIGURE 1
PEAK PULSE POWER VS PULSE TIME

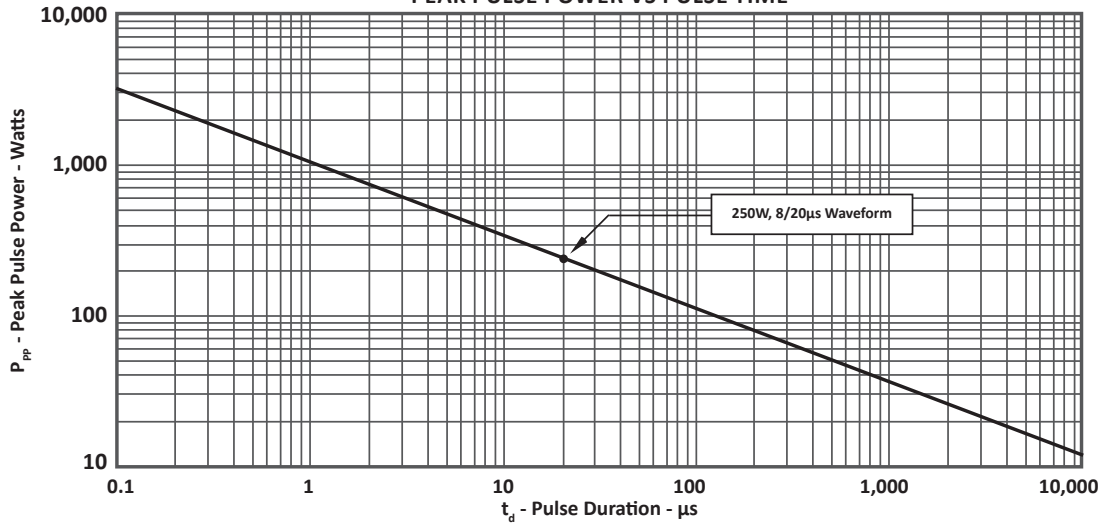


FIGURE 2
PULSE WAVE FORM

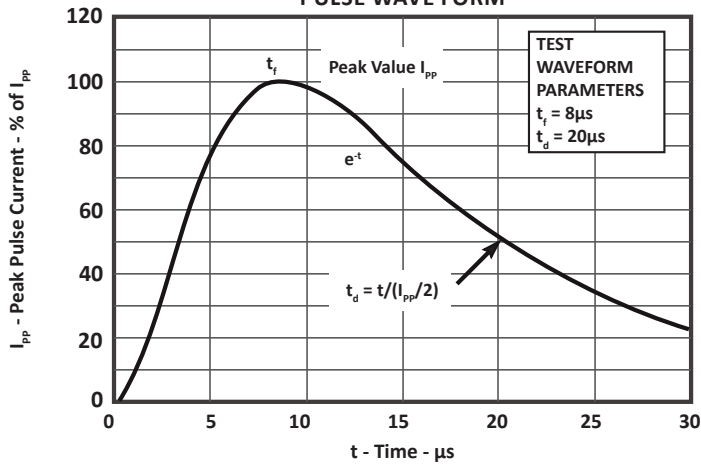
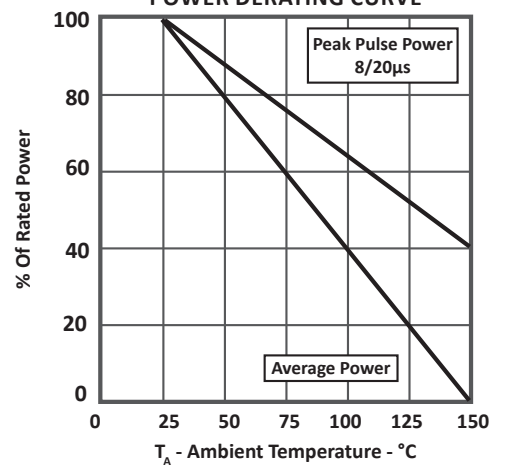


FIGURE 3
POWER DERATING CURVE



TYPICAL DEVICE CHARACTERISTICS

FIGURE 4
OVERSHOOT & CLAMPING VOLTAGE

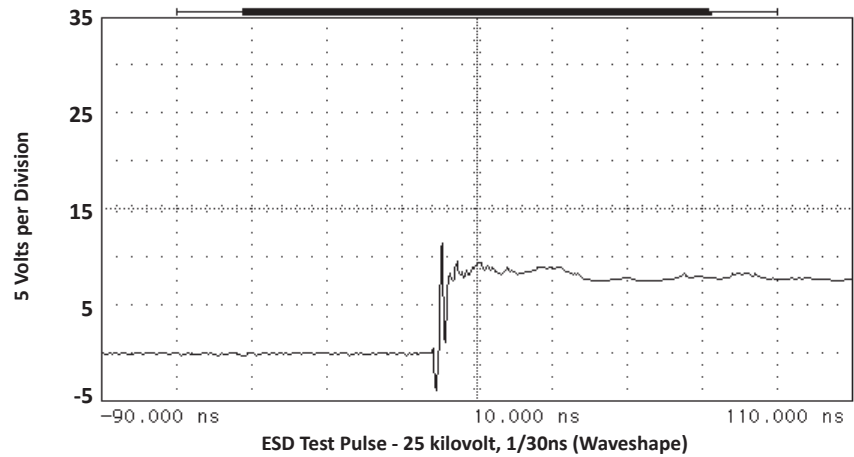
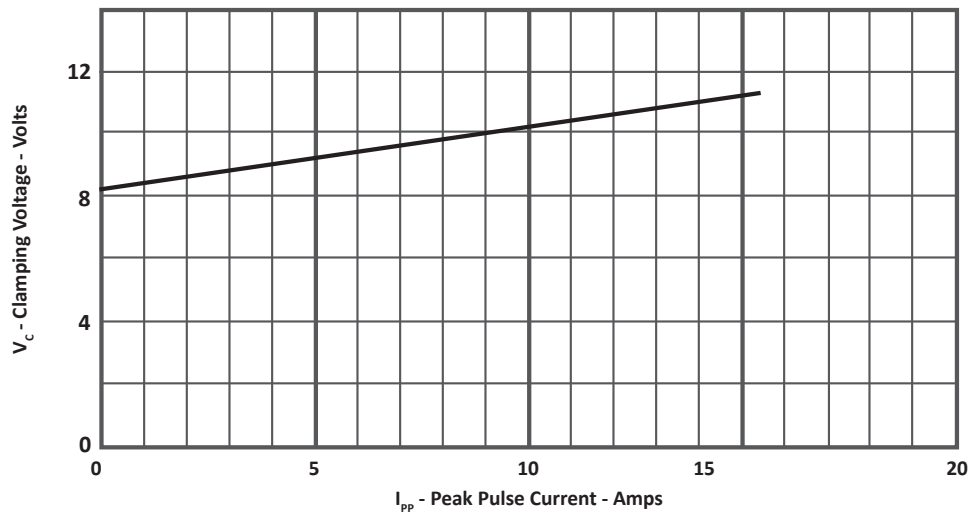


FIGURE 5
TYPICAL CLAMPING VOLTAGE VS PEAK PULSE CURRENT



SPICE MODEL

FIGURE 1
SPICE MODEL FOR



ABD - Avalanche Breakdown Diode (TVS)

TABLE 1 - SPICE PARAMETERS		
PARAMETER	UNIT	ABD(TVS)
BV	V	6
IBV	μ A	1
C_{jo}	pF	20
I_s	A	1E-12
Vj	V	-
M	-	0.33
N	-	1
R_s	Ohms	0.28
TT	s	1E-8
EG	eV	1.11

SOLDER REFLOW INFORMATION

PRINTED CIRCUIT BOARD RECOMMENDATIONS	
PARAMETER	VALUE
Pad Size on PCB	0.275mm
Pad Shape	Round
Pad Definition	Non-Solder Mask Defined Pads
Solder Mask Opening	0.325mm Round
Solder Stencil Thickness	0.150mm
Solder Stencil Aperture Opening (Laser cut, 5% tapered walls)	0.330mm Round
Solder Paste Type	No Clean
Pad Protective Finish	OSP (Entek Cu Plus 106A)
Tolerance - Edge To Corner Ball	±50µm
Solder Ball Side Coplanarity	±20µm
Maximum Dwell Time Above Liquidous (183°C)	60 seconds
Soldering Maximum Temperature	270°C

REQUIREMENTS

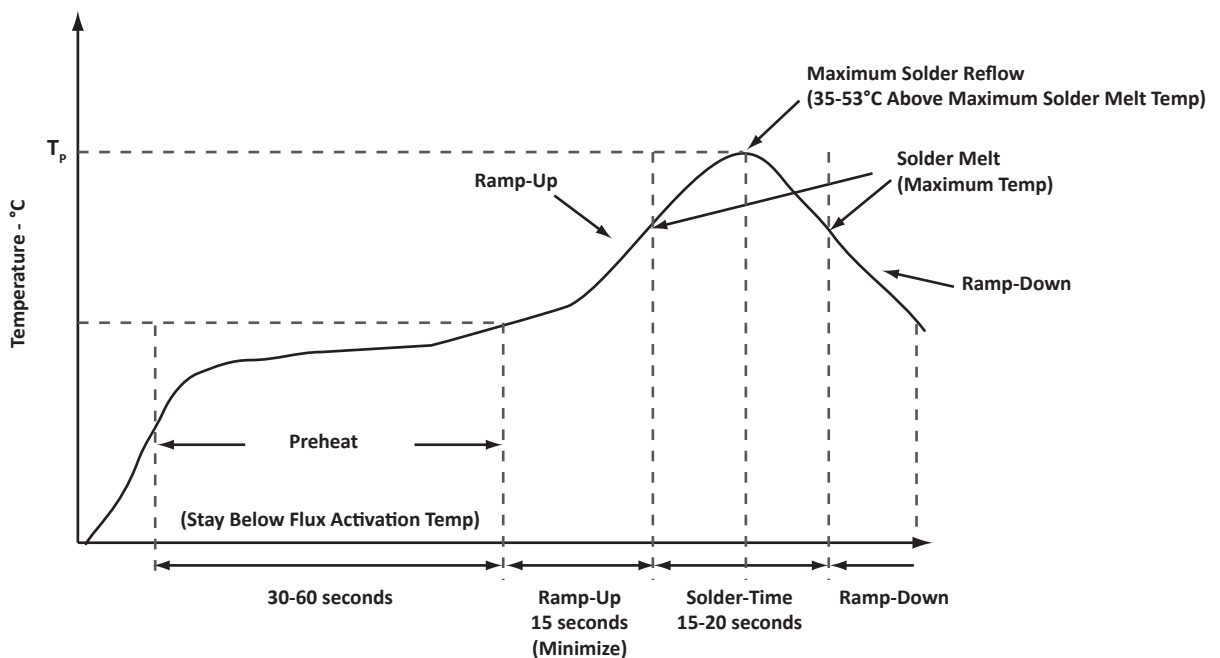
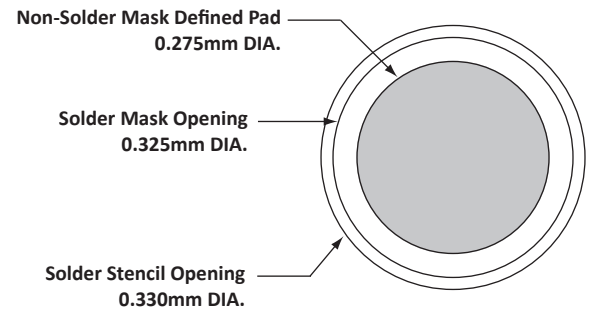
Temperature:

T_p for Lead-Free (Sn/Ag/Cu): 260-270°C

T_p for Tin-Lead: 240-245°C

Preheat time and temperature depends on solder paste and flux activation temperature, component size, weight, surface area and plating.

RECOMMENDED NON-SOLDER MASK DEFINED PAD ILLUSTRATION

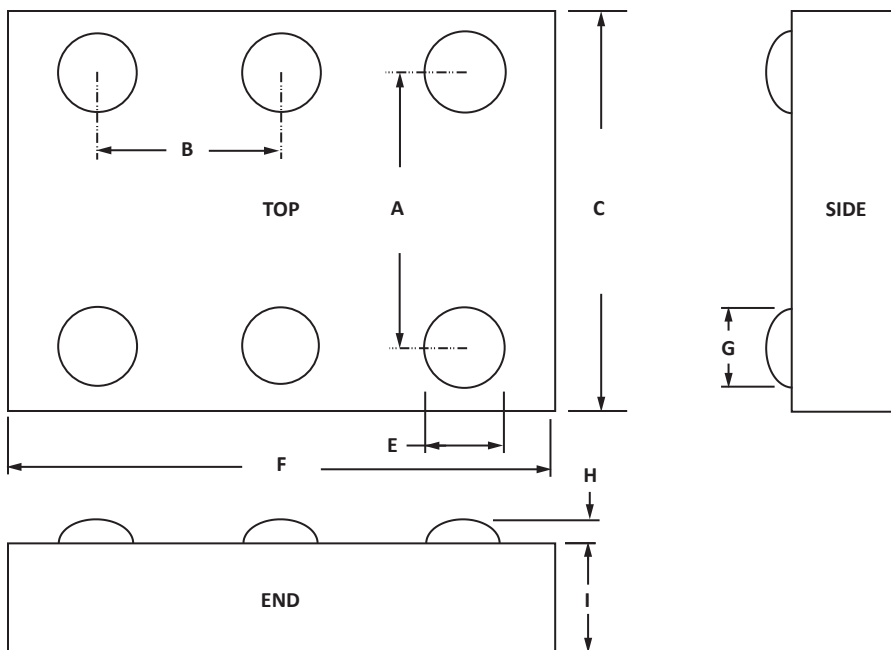


PENTA PACKAGE INFORMATION

OUTLINE DIMENSIONS				
DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	0.510		0.020	
B	0.510		0.020	
C	0.98	1.02	0.038	0.040
E	0.15 SQ		0.006 SQ	
F	1.47	1.53	0.058	0.060
G	0.15		0.006	
H	0.076	0.10	0.003	0.004
I	0.419		0.0165	

NOTES

- Controlling dimensions in inches.
- Decimal tolerance: .xxx ± 0.05mm (0.002").

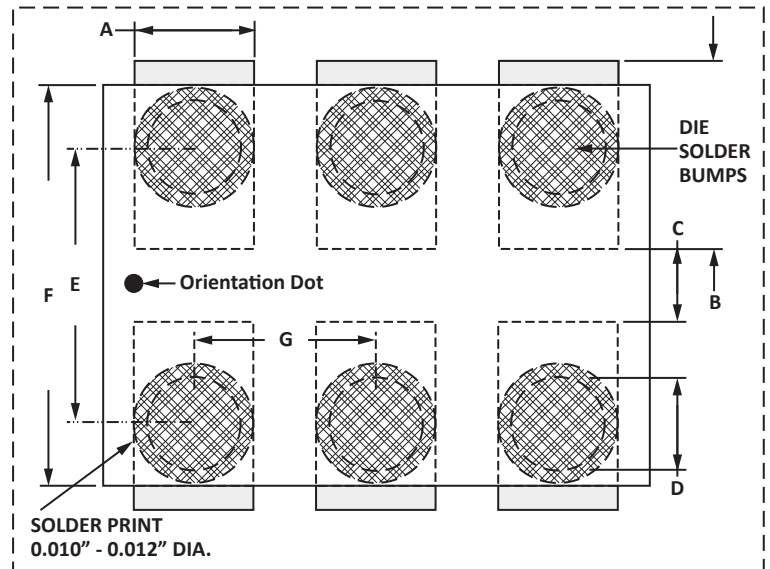


PENTA PACKAGE INFORMATION
OPTION 1 - LAYOUT DIMENSIONS

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	0.305		0.012	
B	0.457		0.018	
C	0.203		0.008	
D	0.254		0.010	
E	0.510		0.020	
F	0.990		0.039	
G	0.510		0.020	

NOTES

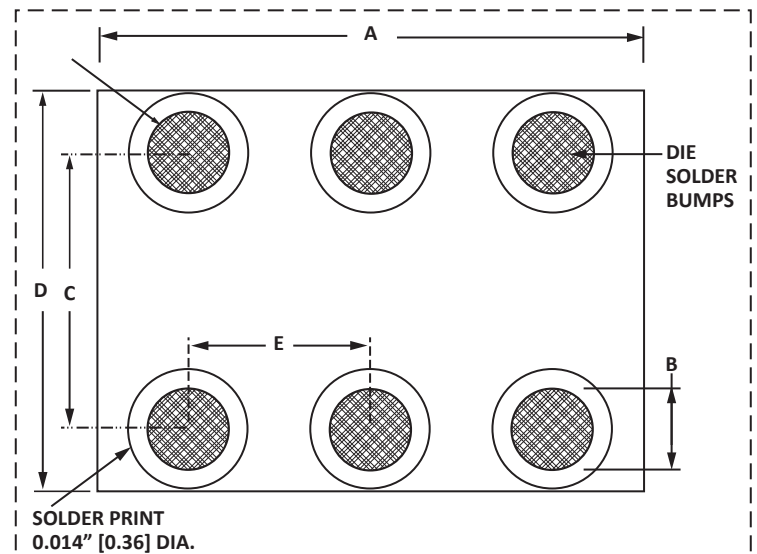
1. Controlling dimensions in inches.
2. Decimal tolerance: .xxx ± 0.05mm (0.002").
3. Preferred: Using 0.1mm (0.004") stencil.

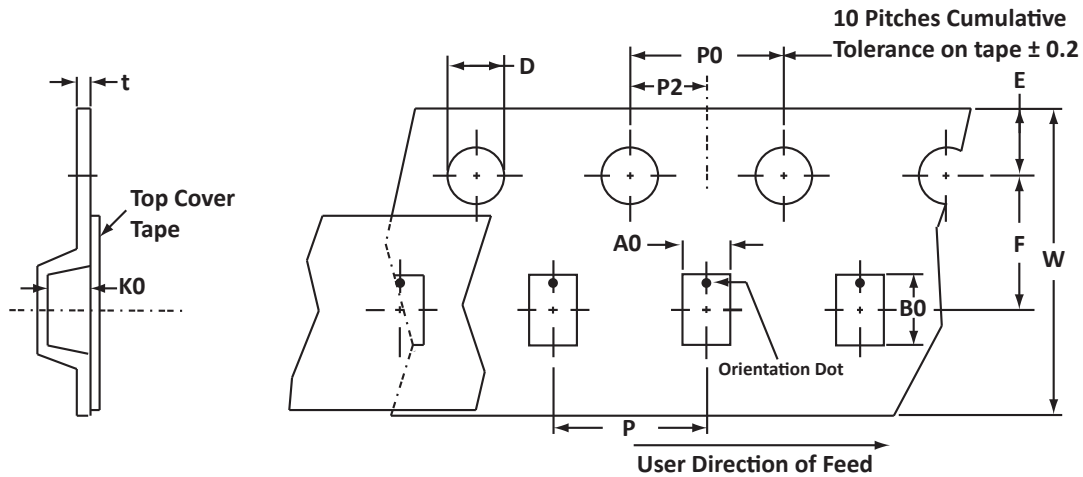

OPTION 2 - LAYOUT DIMENSIONS

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	0.51		0.020	
F	0.15 SQ		0.006 SQ	
G	0.71		0.028	
H	0.99		0.039	
I	0.51		0.020	

NOTES

1. Controlling dimensions in inches.
2. Decimal tolerance: .xxx ± 0.05mm (0.002").
3. Preferred: Using 0.1mm (0.004") stencil.

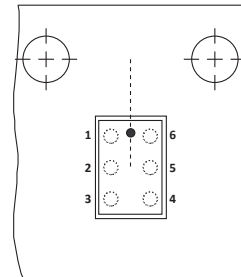


TAPE AND REEL INFORMATION

SPECIFICATIONS

REEL DIA.	TAPE WIDTH	A0	B0	K0	D	E	F	W	P0	P2	P	tmax
178(7")	8	0.80 ± 0.10	1.20 ± 0.10	0.70 ± 0.10	1.50 ± 0.10	1.75 ± 0.10	3.50 ± 0.05	8.00 ± 0.30	4.00 ± 0.12	2.00 ± 0.10	2.00 ± 0.10	0.25

NOTES

1. Dimensions in millimeters.
2. Top view of tape. Solder bumps are face down in tape package.
3. Orientation: preferred stencil - 0.1mm (0.004").
4. Surface mount product is taped and reeled in accordance with EIA 481.
5. 8mm plastic tape: 7" Reels - 5,000 pieces per reel.
6. Marking on Reel - part number, date code and lot number.

TAPE & REEL ORIENTATION


Package outline, pad layout and tape specifications per document number 06038.R2 9/09.

ORDERING INFORMATION

BASE PART NUMBER	LEADFREE SUFFIX	TAPE SUFFIX	QTY/REEL	REEL SIZE	TUBE QTY
SFC05-5	-LF	-T75-1	5,000	7"	n/a

COMPANY INFORMATION

COMPANY PROFILE

ProTek Devices, based in Tempe, Arizona USA, is a manufacturer of Transient Voltage Suppression (TVS) products designed specifically for the protection of electronic systems from the effects of lightning, Electrostatic Discharge (ESD), Nuclear Electromagnetic Pulse (NEMP), inductive switching and EMI/RFI. With over 25 years of engineering and manufacturing experience, ProTek designs TVS devices that provide application specific protection solutions for all electronic equipment/systems.

ProTek Devices Analog Products Division, also manufactures analog interface, control, RF and power management products.

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